

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Chih-Kang Shih</td><td>01/11/2005</td></tr><tr><td>George Huang</td><td>01/11/2005</td></tr><tr><td>Vahan Beibutian</td><td>01/11/2005</td></tr></tbody></table>		Name	Execution Date	Chih-Kang Shih	01/11/2005	George Huang	01/11/2005	Vahan Beibutian	01/11/2005
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Chih-Kang Shih	01/11/2005								
George Huang	01/11/2005								
Vahan Beibutian	01/11/2005								
RECEIVING PARTY DATA									
Name:	H Bank Technology Inc.								
Street Address:	3 Fl. - 1, No. 310, Sunlung Road								
City:	Taipei City								
State/Country:	TAIWAN								
Postal Code:	11058								
PROPERTY NUMBERS Total: 1									
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>11038720</td></tr></tbody></table>		Property Type	Number	Application Number:	11038720				
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Application Number:	11038720								
CORRESPONDENCE DATA									
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NAME OF SUBMITTER:	Spencer K. Warnick								
Total Attachments: 2 source=iptec-0014_signedassignment#page1.tif source=iptec-0014_signedassignment#page2.tif									

OP \$40.00 11038720

PATENT ASSIGNMENT FORM

For and in consideration of good and valuable consideration, the receipt and sufficiency thereof being hereby acknowledged, each undersigned inventor acknowledges his/her prior and ongoing obligation to sell, assign, and transfer, and agrees to sell, assign, and transfer the entire world wide right, title and interest for the United States and all foreign countries, in and to any and all inventions and improvements conceived during and within the scope of his/her employment, and further acknowledges that he/she has sold, assigned, and transferred, and hereby sells, assigns, and transfers, unto:

**H Bank Technology Inc.
3 Fl.-1, No. 310, Sunglung Rd., Taipei City,
Taiwan 11058, R.O.C.**

a corporation of **Taiwan**, and H Bank Technology Inc. desires to acquire all right, title, and interest, in and to the certain inventions (identified below), applications, and any United States and foreign patents to be obtained therefor relating to:

HYDROGEN STORAGE APPARATUS

as set forth in United States Patent Application executed by each undersigned inventor on the date indicated by each inventor signature below, and further identified by Attorney Docket Number IPTEC- 0014;

(select one): executed concurrently herewith or ☒ Serial No. 11/038720 Filed on January 20, 2005

for and to said United States Patent Application including any and all divisions or continuations thereof and in and to any and all Letters Patent of the United States and foreign patents and all rights of priority to be obtained therefor which may issue on any such application or for said invention therein disclosed, including any and all reissues or extensions thereof, to be held and enjoyed by, its successors, legal representatives and assigns to the full end of the term or terms for which any and all such Letters Patent may be granted as fully and entirely as would have been held and enjoyed by the undersigned had this Assignment not been made;

Each undersigned inventor hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all such Letters Patent to H Bank Technology Inc., its successors and assigns, in accordance herewith;

Each undersigned inventor warrants and covenants that he/she has the full and unencumbered right to sell and assign the interests hereby sold and assigned and that he/she has not executed and will not execute any document or instrument in conflict herewith;

Each undersigned inventor further covenants and agrees that he/she, upon the request and at the expense of H Bank Technology Inc., will execute and deliver any papers, make all rightful oaths, testify in any legal proceeding relating to said inventions and improvements, communicate to H Bank Technology Inc. all facts known to the undersigned relating to such inventions and improvements and the history thereof; and perform all other lawful acts deemed necessary or desirable by H Bank Technology Inc., and its legal representatives, to secure, maintain, and enforce patent protection for such inventions and improvements and for vesting title to such inventions and improvements in the inventions; and in particular to perfect title to said above-identified certain inventions, and applications including divisions and continuations thereof, and any and all Letters Patent which may be granted therefor or thereon, including reissues, extensions, or counterparts;

Each undersigned inventor hereby grants H Bank Technology Inc. and the firm of the power to insert in this Assignment any further identification which may be necessary or desirable for recordation of this Assignment.

Executed by Inventor 1 of 3

Signature

Chih-Kang Shih
Chih-Kang Shih

Date:

2005/01/11

Executed by Inventor 2 of 3

Signature

George Huang
George Huang

Date:

2005/1/11

Executed by Inventor 3 of 3

Signature

Vahan Beibetian
Vahan Beibetian

Date:

2005.01.01